



Product Change Notification

Change Notification #: 117814 - 00
Change Title: Intel® RealSense™ Depth Camera D415,
Intel® RealSense™ Depth Camera D435,
Intel® RealSense™ Depth Camera D435i,
PCN 117814-00, Product Material,
Remove the USB cover from bulk orders
Date of Publication: October 9, 2020

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 26, 2020
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Description of Change to the Customer:

The Intel® RealSense™ Depth Camera SKUs listed in the Product Affected table below will have the following change.

- Removing the USB cover from bulk orders.



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customer.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#
82635ASRCVKMP	962304
82635AWGDVKPMP	962305
82635D435IDKMP	999AXG

PCN Revision History:

Date of Revision:

October 9, 2020

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

117814 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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